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Response Under 37 C.F.R.§1.116 Examining Group 2826 Expedited Procedure

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s):

Jack O. Chu, et al.

Examiner:

Johannes P. MONDT

Serial No:

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GROWTH OF Si_{1-x-y} Ge_xC_y AND Si_{1-y}C_y ALLOY LAYERS ON Si BY UHV-CVD

Confirmation Number: 1038

Mail Stop AF Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

RESPONSE UNDER 37 C.F.R. § 1.116

Sir:

In response to the Final Office Action dated October 3, 2005, Applicants hereby submit the following amendments and remarks for entry of record in the above-identified patent application.

CERTIFICATE OF MAILING UNDER 37 C.F.R. §1.8(a)

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to Mail Stop AF, Commissioner of Patents, P.O. Box 1450, Alexandria, VA 22313-1/4500n December 5, 2005

Dated: December 5, 2005

Leste S. Szivos, Ph.D.